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PGA103

Programmable Gain
AMPLIFIER

FEATURES

● **DIGITALLY PROGRAMABLE GAINS:**
  G=1, 10, 100V/V
● **CMOS/TTL-COMPATIBLE INPUTS**
● **LOW GAIN ERROR: ±0.05% max, G=10**
● **LOW OFFSET VOLTAGE DRIFT: 2μV/°C**
● **LOW QUIESCENT CURRENT: 2.6mA**
● **LOW COST**
● **8-PIN PLASTIC DIP, SO-8 PACKAGES**

APPLICATIONS

● **DATA ACQUISITION SYSTEMS**
● **GENERAL PURPOSE ANALOG BOARDS**
● **MEDICAL INSTRUMENTATION**

DESCRIPTION

The PGA103 is a programmable-gain amplifier for general purpose applications. Gains of 1, 10, or 100 are digitally selected by two CMOS/TTL-compatible inputs. The PGA103 is ideal for systems that must handle wide dynamic range signals.

The PGA103's high speed circuitry provides fast settling time, even at G=100 (8μs to 0.01%). Bandwidth is 250kHz at G=100, yet quiescent current is only 2.6mA. It operates from ±4.5V to ±18V power supplies.

The PGA103 is available in 8-pin plastic DIP and SO-8 surface-mount packages, specified for the –40°C to +85°C temperature range.
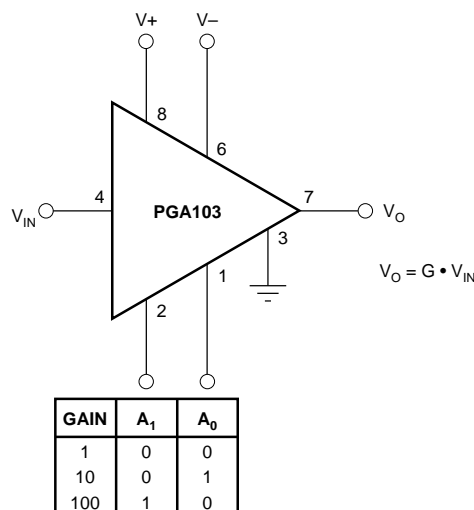
$V_O = G \cdot V_{IN}$

GAIN	A_1	A_0
1	0	0
10	0	1
100	1	0

SPECIFICATIONS

ELECTRICAL

T_A = +25°C, V_S = ±15V, R_L = 2kΩ unless otherwise specified.

PARAMETER	CONDITIONS	PGA103P, U			UNITS
		MIN	TYP	MAX	
INPUT					
Offset Voltage, RTI					
G = 1	T_A = +25°C		±200	±1500	µV
G = 10			±100	±500	µV
G = 100			±100	±500	µV
vs Temperature	T_A = T_{MIN} to T_{MAX}				
G = 1			±5		µV/°C
G = 10			±2		µV/°C
G = 100			±2		µV/°C
vs Power Supply	V_S = ±4.5V to ±18V				
G = 1			30	70	µV/V
G = 10			10	35	µV/V
G = 100			10	35	µV/V
Impedance			10^8 ‖ 2		Ω ‖ pF
INPUT BIAS CURRENT					
Initial Bias Current			±50	±150	nA
vs Temperature			±100		pA/°C
NOISE VOLTAGE, RTI	G = 100, R_S = 0Ω				
f = 10Hz			16		nV/√Hz
f = 100Hz			11		nV/√Hz
f = 1kHz			11		nV/√Hz
f_B = 0.1Hz to 10Hz			0.6		µVp-p
NOISE CURRENT					
f = 10Hz			2.8		pA/√Hz
f = 1kHz			0.3		pA/√Hz
f_B = 0.1Hz to 10Hz			76		pAp-p
GAIN					
Gain Error					
G = 1			±0.005	±0.02	%
G = 10			±0.02	±0.05	%
G = 100			±0.04	±0.2	%
Gain vs Temperature					
G = 1			±2		ppm/°C
G = 10			±10		ppm/°C
G = 100			±30		ppm/°C
Nonlinearity					
G = 1			±0.001	±0.003	% of FSR
G = 10			±0.002	±0.005	% of FSR
G = 100			±0.004	±0.01	% of FSR
OUTPUT					
Voltage, Positive		(V+) −3.5	(V+) −2.5		V
Negative		(V−) +3.5	(V−) +2.5		V
Load Capacitance, max			1000		pF
Short-Circuit Current			±25		mA
FREQUENCY RESPONSE					
Bandwidth, −3dB					
G = 1			1.5		MHz
G = 10			750		kHz
G = 100			250		kHz
Slew Rate	V_O = ±10V		9		V/µs
Settling Time, 0.1%					
G = 1			2		µs
G = 10			2.2		µs
G = 100			6.5		µs
Settling Time, 0.01%					
G = 1			2.5		µs
G = 10			2.5		µs
G = 100			8		µs
Overload Recovery	50% Overdrive		2.5		µs
DIGITAL LOGIC INPUTS					
Digital Low Voltage		−5.6		0.8	V
Digital Low or High Current			1		µA
Digital High Voltage		2		V+	V

SPECIFICATIONS (CONT)

ELECTRICAL

T_A = +25°C, V_S = ±15V, R_L = 2kΩ unless otherwise specified.

PARAMETER	CONDITIONS	PGA103P, U			UNITS
		MIN	TYP	MAX	
POWER SUPPLY					
Voltage Range		±4.5	±15	±18	V
Current	V_{IN} = 0V		±2.6	±3.5	mA
TEMPERATURE RANGE					
Specification		−40		+85	°C
Operating		−40		+125	°C
θ_{JA}: P or U Package			100		°C/W

PIN CONFIGURATION

```
Top View                          DIP/SO-8

         ┌─────┐──┌─────┐
  A₀  │ 1 │        │ 8 │  V+
  A₁  │ 2 │        │ 7 │  V_O
Ground│ 3 │        │ 6 │  V−
  V_IN│ 4 │        │ 5 │  NC
         └───────────────┘
```

ORDERING INFORMATION

MODEL	PACKAGE	TEMPERATURE RANGE
PGA103P	8-Pin Plastic DIP	−40°C to +85°C
PGA103U	SO-8 Surface-Mount	−40°C to +85°C
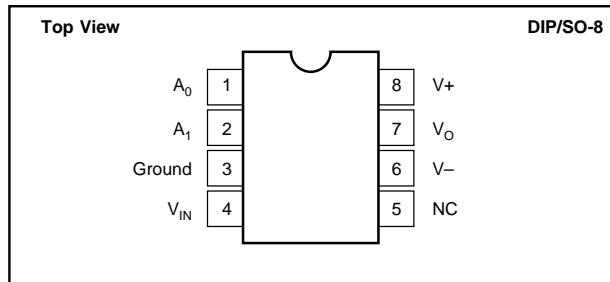
ABSOLUTE MAXIMUM RATINGS

Supply Voltage .... ±18V
Analog Input Voltage Range .... V− to V+
Logic Input Voltage Range .... V− to V+
Output Short Circuit (to ground) .... Continuous
Operating Temperature .... −40°C to +125°C
Storage Temperature .... −40°C to +125°C
Junction Temperature .... +150°C
Lead Temperature (soldering,10s) .... +300°C

PACKAGE INFORMATION

MODEL	PACKAGE	PACKAGE DRAWING NUMBER[1]
PGA103P	8-Pin Plastic DIP	006
PGA103U	SO-8 Surface-Mount	182

NOTE: (1) For detailed drawing and dimension table, please see end of data sheet, or Appendix D of Burr-Brown IC Data Book.

⚠️ ELECTROSTATIC DISCHARGE SENSITIVITY

Any integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet published specifications.

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DICE INFORMATION
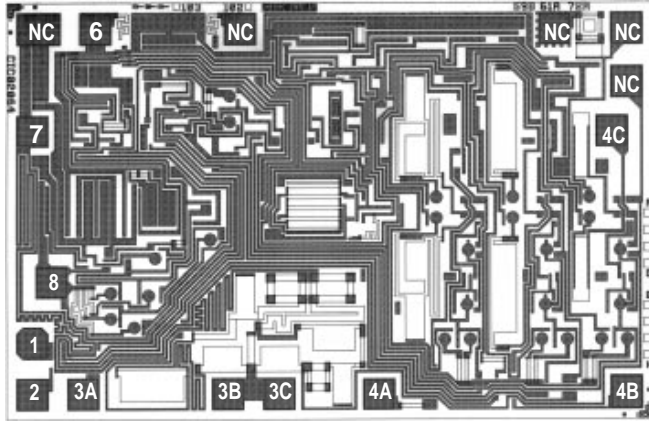
PGA103 DIE TOPOGRAPHY

PAD	FUNCTION
1	A_0
2	A_1
3A, 3B, 3C[1]	Ground
4A, 4B, 4C[2]	V_{IN}
6	V–
7	V_O
8	V+

NC: No Connection
NOTES: (1) Connect all three indicated pads. (2) Connect all three indicated pads.
Substrate Bias: Internally connected to V– power supply.

MECHANICAL INFORMATION

	MILS (0.001")	MILLIMETERS
Die Size	69 x 105 ±5	1.75 x 2.67 ±0.13
Die Thickness	20 ±3	0.51 ±0.08
Min. Pad Size	4 x 4	0.1 x 0.1
Backing		Gold

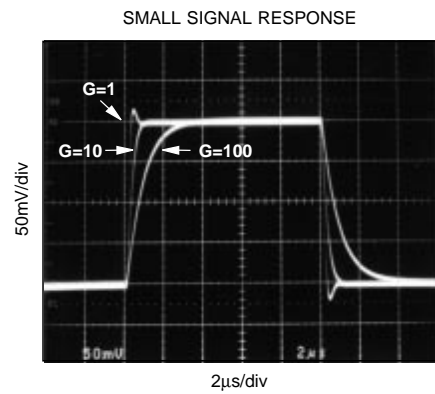# TYPICAL PERFORMANCE CURVES

T_A = +25°C, V_S = ±15V unless otherwise noted.

VOLTAGE GAIN vs FREQUENCY

POWER SUPPLY REJECTION vs FREQUENCY
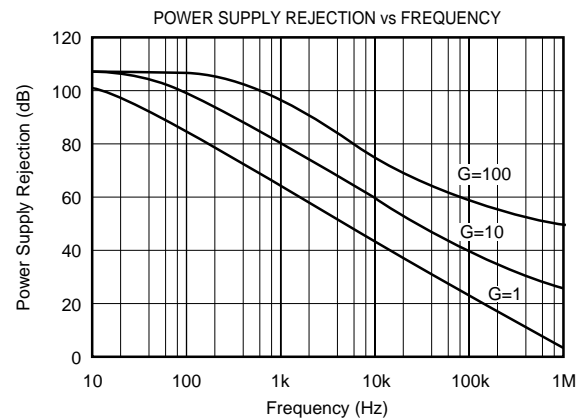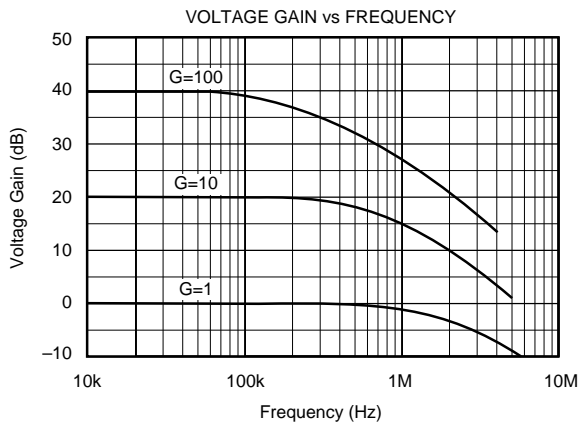
TYPICAL PERFORMANCE CURVES (CONT)

T_A = +25°C, V_S = ±15V unless otherwise noted.

INPUT VOLTAGE NOISE vs FREQUENCY

Voltage Noise (nV/$\sqrt{Hz}$) vs Frequency (Hz)

G=1
G=10
G=100
Bandwidth Limited

INPUT CURRENT NOISE vs FREQUENCY

Current Noise (pA/$\sqrt{Hz}$) vs Frequency (Hz)

All Gains

QUIESCENT CURRENT vs TEMPERATURE

Quiescent Current (mA) vs Temperature (°C)

SMALL SIGNAL RESPONSE

G=1
G=10
G=100

50mV/div

50mV

2µs

2µs/div

LARGE SIGNAL RESPONSE

G=10
G=1
G=100

5V/div

5V

2µs

2µs/div

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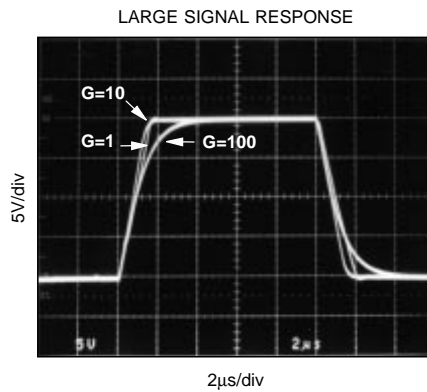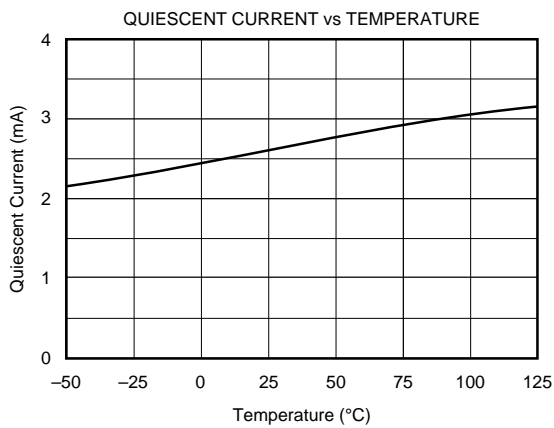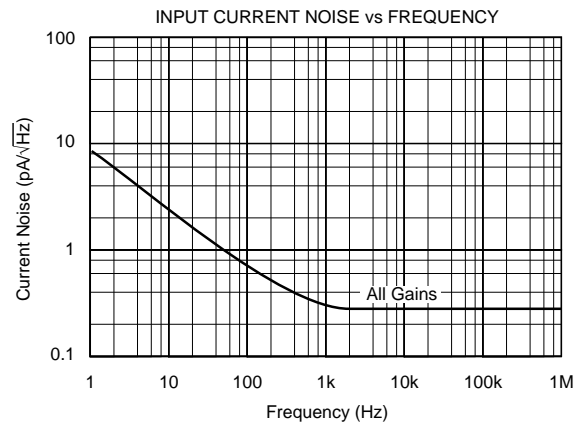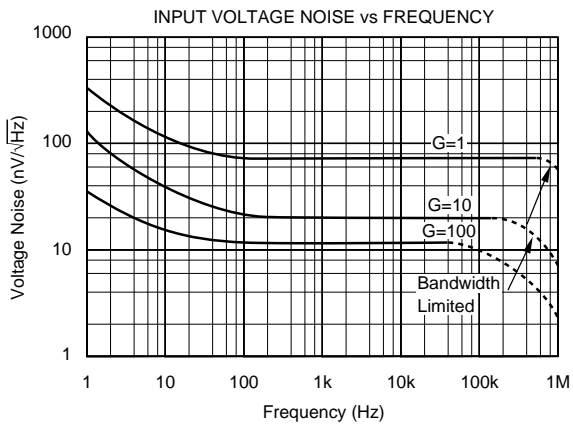
APPLICATION INFORMATION

Figure 1 shows the basic connections required for operation of the PGA103. Applications with noisy or high impedance power supplies may require decoupling capacitors close to the device pins as shown.
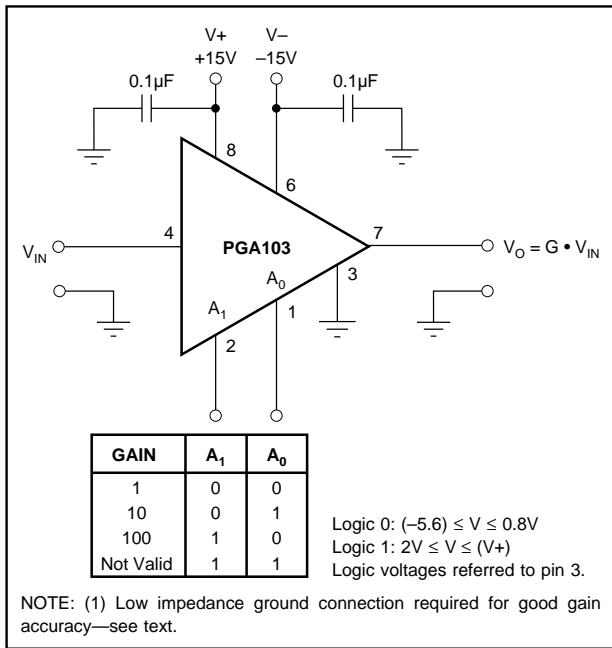

FIGURE 1. Basic Connections.

The input and output are referred to the ground terminal, pin 3. This must be a low-impedance connection to assure good gain accuracy. A resistance of 0.1Ω in series with the ground pin will cause the gain in G=100 to decrease by approximately 0.2%.

DIGITAL INPUTS

The digital inputs, A_0 and A_1, select the gain according to the logic table in Figure 1. The digital inputs interface directly to common CMOS and TTL logic components. The logic inputs are referenced to the ground terminal, pin 3.

The logic table in Figure 1 shows that logic "1" on both A_0 and A_1 is invalid. This logic code will not cause damage, but the amplifier output will not be predictable while this code is selected. The output will recover when a valid code is selected.

The digital inputs are not latched, so a change in logic inputs immediately selects a new gain. Switching time of the logic is approximately $0.5\mu s$. The time to respond to gain change is equal to the switching time plus the time it takes the amplifier to settle to a new output voltage in the newly selected gain (see settling time specifications).

Many applications use an external logic latch to access gain control signals from a high speed data bus. Using an external latch isolates the high speed digital bus from sensitive analog circuitry. Locate the latch circuitry as far as practical from analog circuitry to avoid coupling digital noise into the analog circuitry.

Some applications select gain of the PGA103 with switches or jumpers. Figure 2 shows pull-up resistors connected to assure a noise-free logic "1" when the switch or jumper is off or open. Fixed-gain applications can connect the logic inputs directly to V+ or ground (or other valid logic level) without a series resistor.
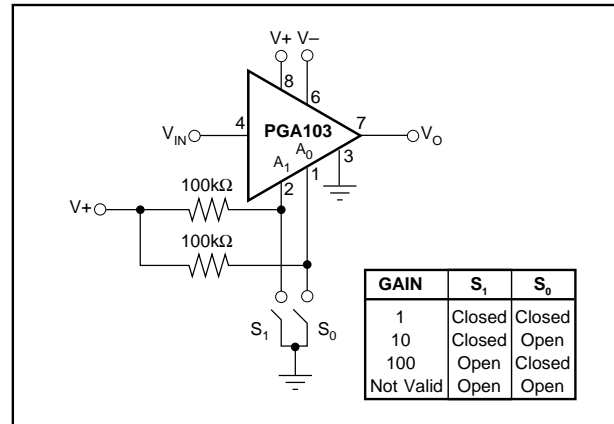

FIGURE 2. Switch or Jumper-Selected Gains.

OFFSET TRIMMING

Offset voltage is laser-trimmed to typically less than $200\mu V$ (referred to input) in all three gains. The input-referred offset voltage can be different for each gain.
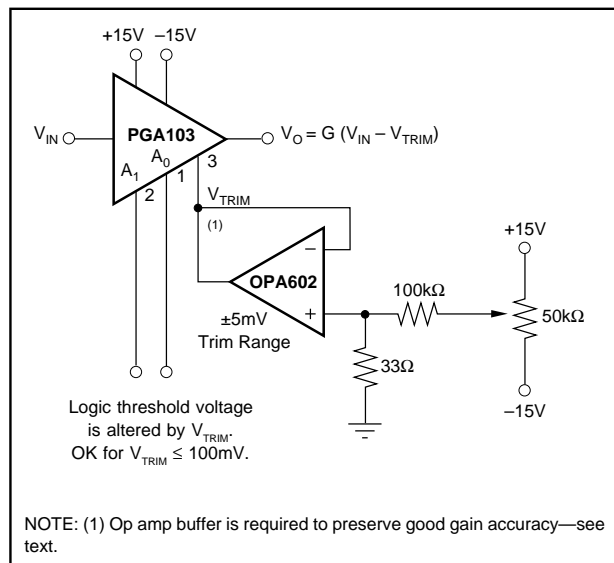

FIGURE 3. Offset Voltage Trim Circuit.

Figure 3 shows a circuit used to trim the offset voltage of the PGA103. An op amp buffers the trim voltage to provide a low impedance at the ground terminal. This is required to maintain accurate gain. Remember that the logic inputs, A_0 and A_1, are referenced to this ground connection, so the logic threshold voltage will be affected by the trim voltage. This is insignificant if the offset adjustment is used only to trim offset voltage. If a large offset is used (greater than 0.1V), be sure that the logic input signals provide valid logic levels when referred to the voltage at the ground terminal, pin 3.
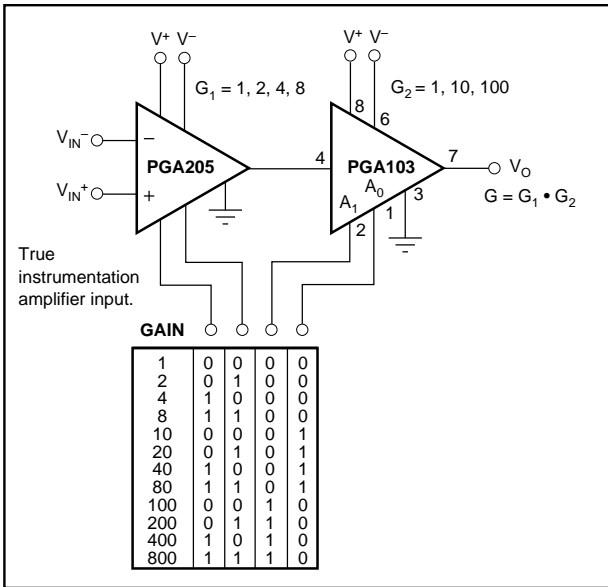
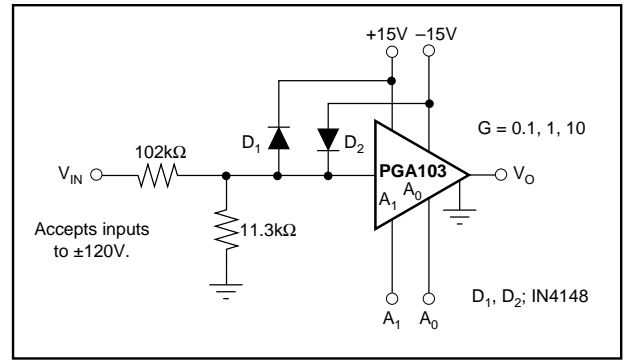FIGURE 4. Programmable Gain Instrumentation Amplifier.

GAIN

1	0	0	0	0
2	0	1	0	0
4	1	0	0	0
8	1	1	0	0
10	0	0	0	1
20	0	1	0	1
40	1	0	0	1
80	1	1	0	1
100	0	0	1	0
200	0	1	1	0
400	1	0	1	0
800	1	1	1	0

FIGURE 5. Wide Input Voltage Range Amplifer.

MODEL	CHARACTERISTICS
INA103	Low Noise, 1nV/√Hz IA
INA105	G = 1 Difference Amp
INA106	G = 10 Difference Amp
INA114	Resistor-Programmed Gain, Precision
INA117	±200V C-M Input Range Difference Amp
INA111	FET Input, High Speed IA
INA131	Precision, G = 100 IA
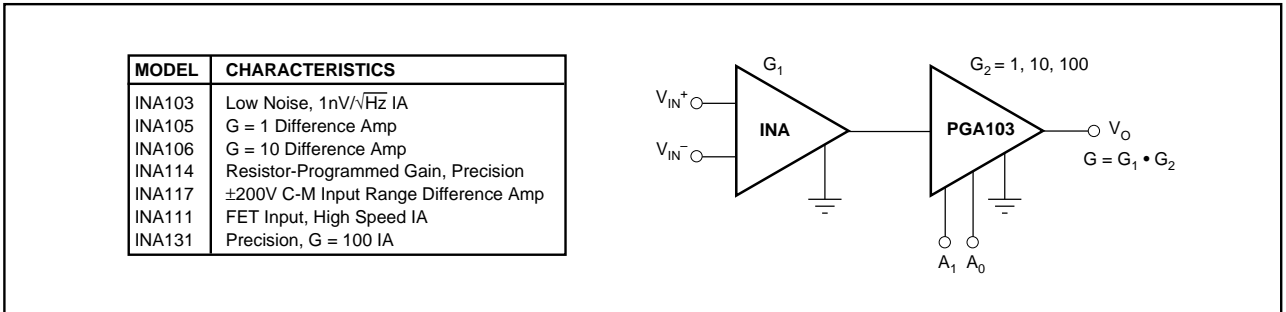
FIGURE 6. Instrumentation Amplifier with Programmable Gain Output Amp.

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PACKAGING INFORMATION

ORDERABLE DEVICE	STATUS(1)	PACKAGE TYPE	PACKAGE DRAWING	PINS	PACKAGE QTY
PGA103P	OBSOLETE	PDIP	P	8	
PGA103U	ACTIVE	SOIC	D	8	100

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

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